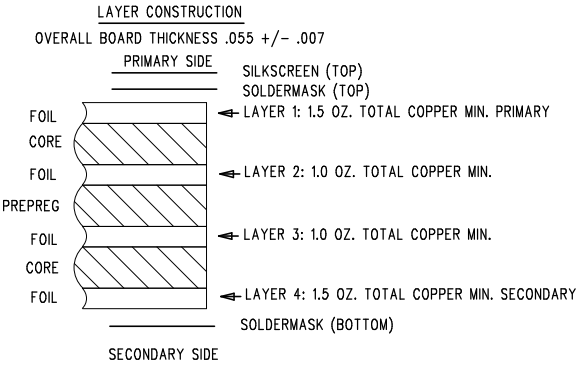


DWG NO.	SH	REV	1		
		REVISIONS			
		REV	DESCRIPTION	DATE	APPROVED

NOTES: UNLESS OTHERWISE SPECIFIED

- PCB'S SHALL BE RoHS COMPLIANT.
- MATERIAL: LEAD-FREE ASSEMBLY PROCESS MATERIAL.
- BOARD SHALL BE FABRICATED IN ACCORDANCE TO IPC-6012 CLASS 2 TYPE X. FABRICATION PROCESS SHALL BE UL APPROVED AND PCB SHALL BE IDENTIFIED WITH MANUFACTURERS APPROVED LOGO AND TYPE DESIGNATION IN ETCH.
- PLATED THRU HOLES SHALL HAVE A MINIMUM OF 0.001" THICK PLATING.
- SOLDERMASK BOTH SIDES OF BOARD USING A LIQUID PHOTO-IMAGEABLE (LPI) MATERIAL. HOLES, EDGE CONNECTORS, AND TERMINAL AREAS SHALL BE FREE OF SOLDERMASK.
- SILKSCREEN LEGEND OVER SOLDERMASK USING A NON-CONDUCTIVE EPOXY INK, COLOR WHITE.
- BOARD FINISH SHALL BE 3-5u" IMMERSION GOLD OVER 100-200u" ELECTROLESS NICKEL.
- SOLDERMASK SHALL BE SOLDERMASK OVER BARE COPPER (SMOBC), COLOR GREEN.
- LAYER TO LAYER REGISTRATION TO BE WITHIN +/-0.003".
- WARP AND TWIST SHALL NOT EXCEED 0.010"/".
- ALL DIMENSIONS ARE IN INCHES.
- DESIGN RULES:
  - MINIMUM TRACE WIDTH IS .008".
  - MINIMUM TRACE-TO-TRACE IS .008".
  - MINIMUM TRACE-TO-PAD IS .008".
  - MINIMUM PAD-TO-PAD IS .007".
  - .009" WIDTH TRACE TO BE 50 OHMS ON LAYER 1.
- PROFILE TOLERANCES FOR INSIDE CORNERS IS .060" RADIUS MAX.



OPTION	QTY./ ASSY.	PART OR IDENT. NO.	NOMENCLATURE OR DESCRIPTION	MATERIAL/SPECIFICATION	ITEM NO.
PARTS LIST					
UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES TOLERANCES DECIMALS .XX %p .01 .XXX %p .005 FINISH DO NOT SCALE DRAWING 63/			CONTRACT NO.		
			DRAWN MARSCHALL MARKETING	DATE 5/7/2010	TITLE  WI2WI INC.  FABRICATION DRAWING W2SW0011 TEST BOARD
			CHECK		
			PROJ ENGR		
MATERIAL			ASSY		
			MFG ENGR		
			QA ENGR		
			RLSE DATE		
SIZE B		CAGE NO. TBD		DWG NO XXXXXXX	REV 1
SCALE		WEIGHT		SHEET 1	OF 1